

## P-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY		
$V_{DS}$ (V)	$R_{DS(on)}$ ( $\Omega$ )	$I_D$ (A)
- 30	0.035 at $V_{GS} = - 10$ V	- 6.2
	0.053 at $V_{GS} = - 4.5$ V	- 5.0

### FEATURES

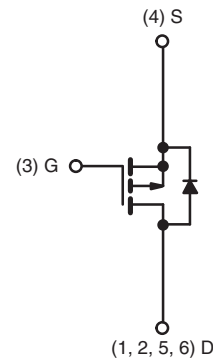
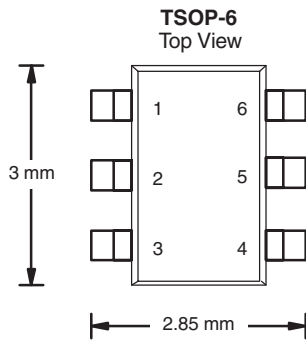
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- Compliant to RoHS Directive 2002/95/EC



**RoHS**  
COMPLIANT  
**HALOGEN**  
**FREE**  
Available

### APPLICATIONS

- Load Switch



P-Channel MOSFET

Ordering Information: Si3483DV-T1-E3 (Lead (Pb)-free)  
Si3483DV-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS $T_A = 25$ °C, unless otherwise noted					
Parameter	Symbol	5 s	Steady State	Unit	
Drain-Source Voltage	$V_{DS}$	- 30		V	
Gate-Source Voltage	$V_{GS}$	$\pm 20$			
Continuous Drain Current ( $T_J = 150$ °C) <sup>a</sup>	$I_D$	$T_A = 25$ °C	- 6.2	- 4.7	A
		$T_A = 70$ °C	- 4.9	- 3.7	
Pulsed Drain Current	$I_{DM}$	- 25			
Continuous Source Current (Diode Conduction) <sup>a</sup>	$I_S$	- 1.7	- 0.95		
Maximum Power Dissipation <sup>a</sup>	$P_D$	$T_A = 25$ °C	2.0	1.14	W
		$T_A = 70$ °C	1.3	0.73	
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	- 55 to 150		°C	

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>a</sup>	$R_{thJA}$	$t \leq 5$ s	45	62.5	°C/W
		Steady State	90	110	
Maximum Junction-to-Foot (Drain)	$R_{thJF}$	25	30		

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

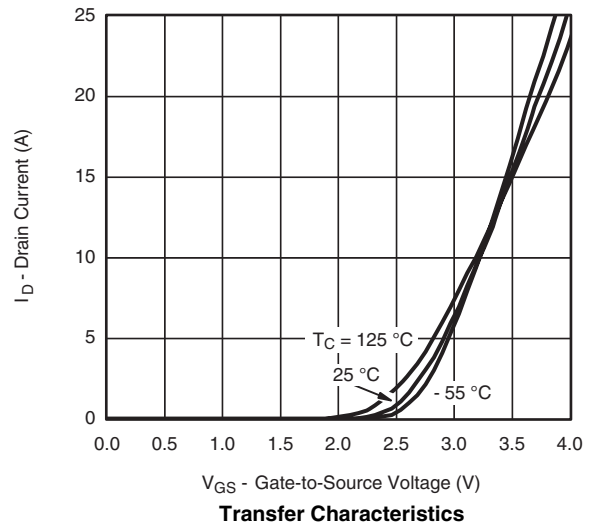
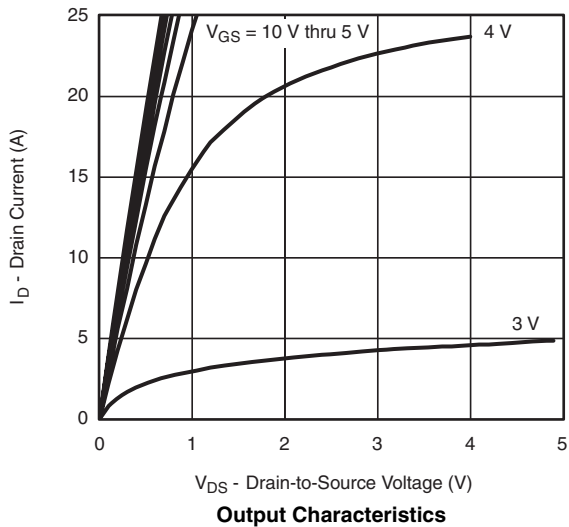
SPECIFICATIONS $T_J = 25^\circ\text{C}$ , unless otherwise noted						
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
<b>Static</b>						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250 \mu\text{A}$	-1.0		-3	V
Gate-Body Leakage	$I_{GSS}$	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$			-1	$\mu\text{A}$
		$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 85^\circ\text{C}$			-5	
On-State Drain Current <sup>a</sup>	$I_{D(on)}$	$V_{DS} \leq -5 \text{ V}, V_{GS} = -10 \text{ V}$	-25			A
Drain-Source On-State Resistance <sup>a</sup>	$R_{DS(on)}$	$V_{GS} = -10 \text{ V}, I_D = -6.2 \text{ A}$		0.028	0.035	$\Omega$
		$V_{GS} = -4.5 \text{ V}, I_D = -5.0 \text{ A}$		0.042	0.053	
Forward Transconductance <sup>a</sup>	$g_{fs}$	$V_{DS} = -15 \text{ V}, I_D = -6.2 \text{ A}$		14		S
Diode Forward Voltage <sup>a</sup>	$V_{SD}$	$I_S = -1.7 \text{ A}, V_{GS} = 0 \text{ V}$		-0.8	-1.2	V
<b>Dynamic<sup>b</sup></b>						
Total Gate Charge	$Q_g$	$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -6.2 \text{ A}$		23	35	nC
Gate-Source Charge	$Q_{gs}$			3.6		
Gate-Drain Charge	$Q_{gd}$			6		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = -15 \text{ V}, R_L = 15 \Omega$ $I_D \cong -1 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 6 \Omega$		10	15	ns
Rise Time	$t_r$			10	15	
Turn-Off Delay Time	$t_{d(off)}$			71	110	
Fall Time	$t_f$			45	70	
Source-Drain Reverse Recovery Time	$t_{rr}$	$I_F = -1.7 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}$		45	70	

Notes:

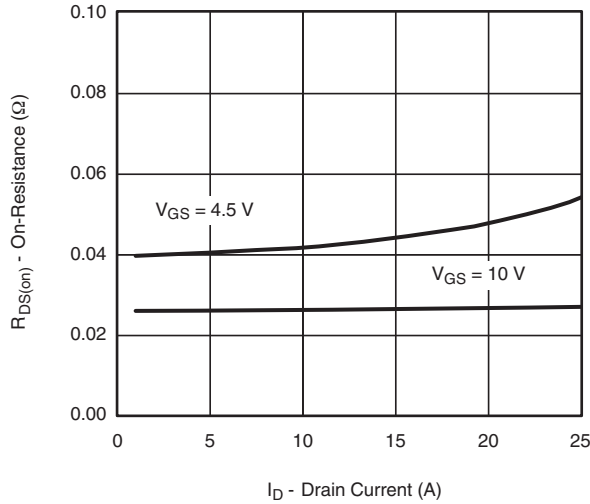
- a. Pulse test; pulse width  $\leq 300 \mu\text{s}$ , duty cycle  $\leq 2\%$ .
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

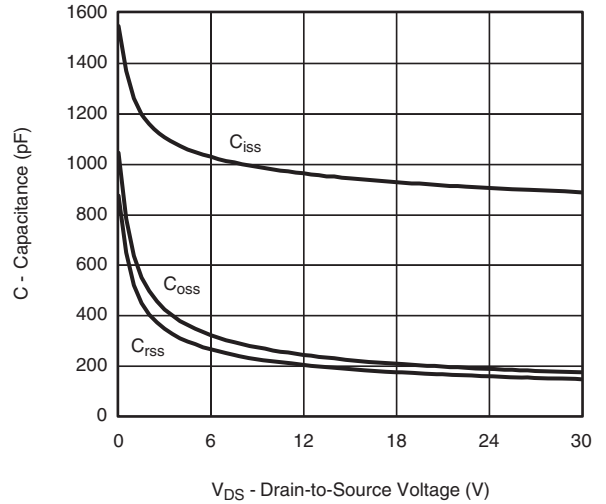
**TYPICAL CHARACTERISTICS**  $25^\circ\text{C}$ , unless otherwise noted



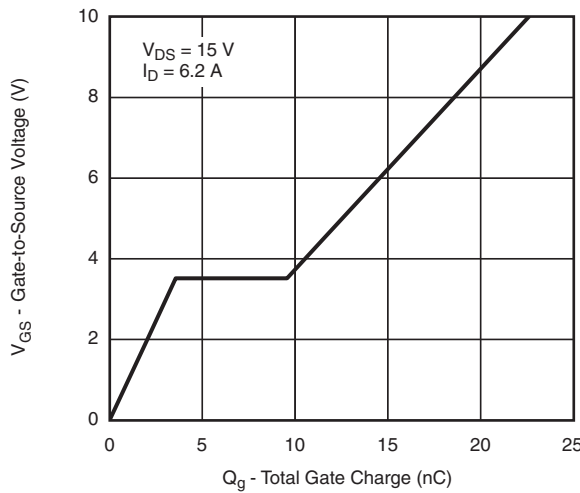
## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



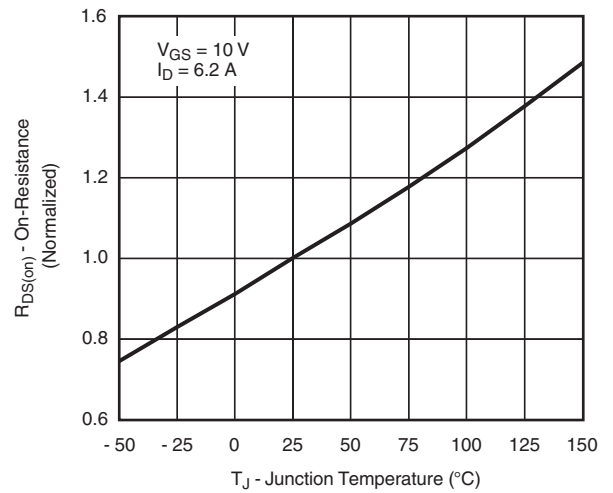
$I_D$  - Drain Current (A)  
**On-Resistance vs. Drain Current**



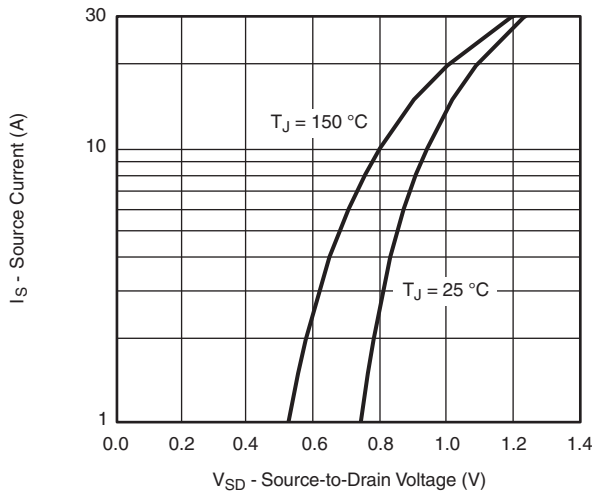
$V_{DS}$  - Drain-to-Source Voltage (V)  
**Capacitance**



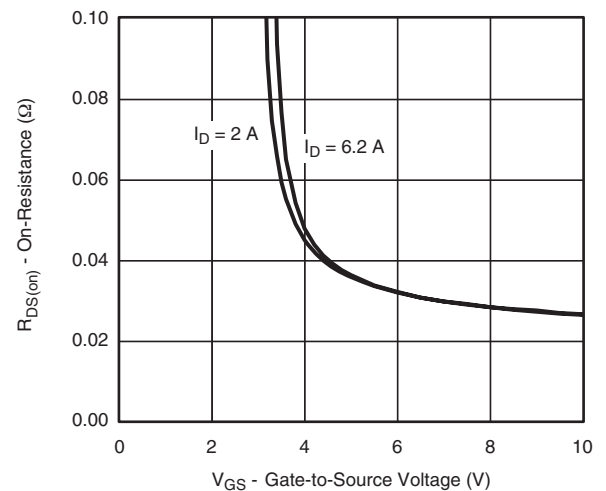
$Q_g$  - Total Gate Charge (nC)  
**Gate Charge**



$T_J$  - Junction Temperature ( $^{\circ}\text{C}$ )  
**On-Resistance vs. Junction Temperature**

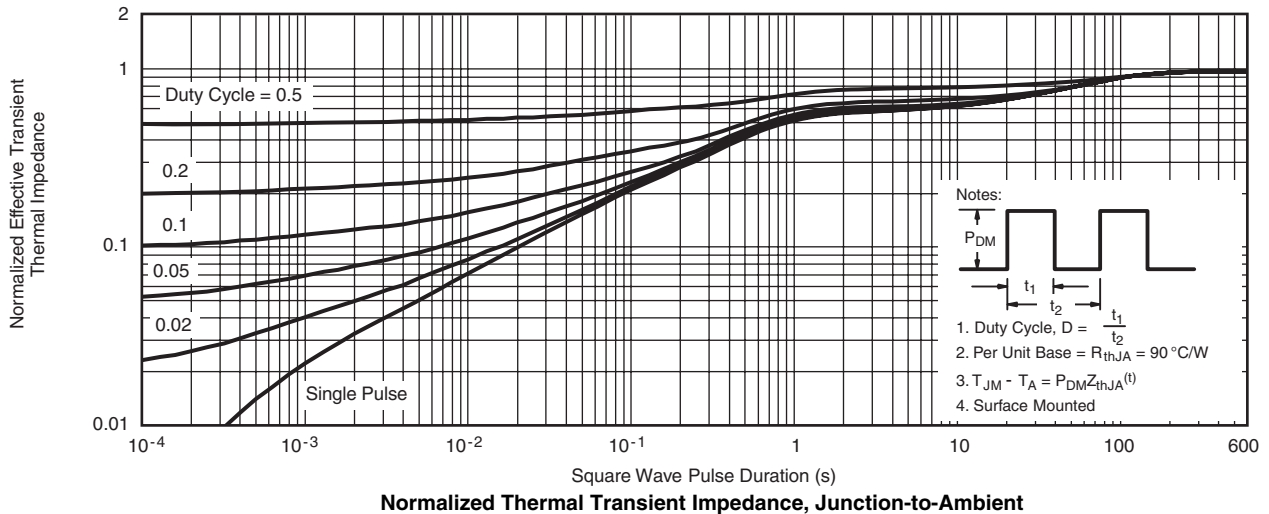
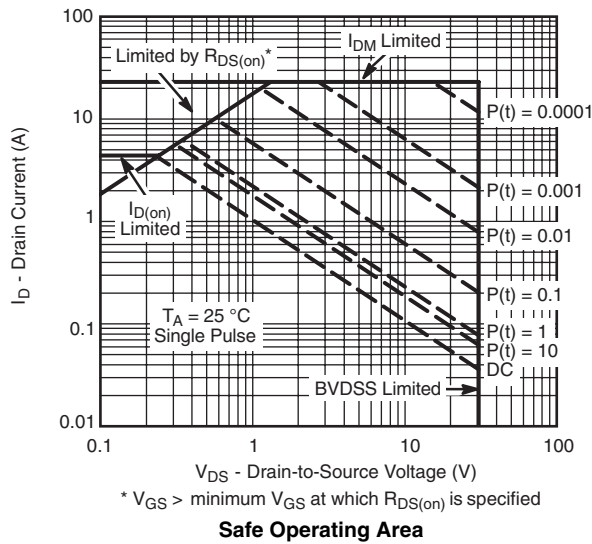
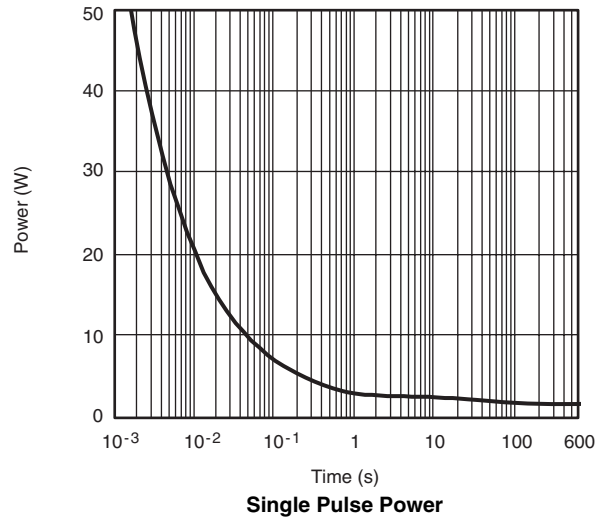
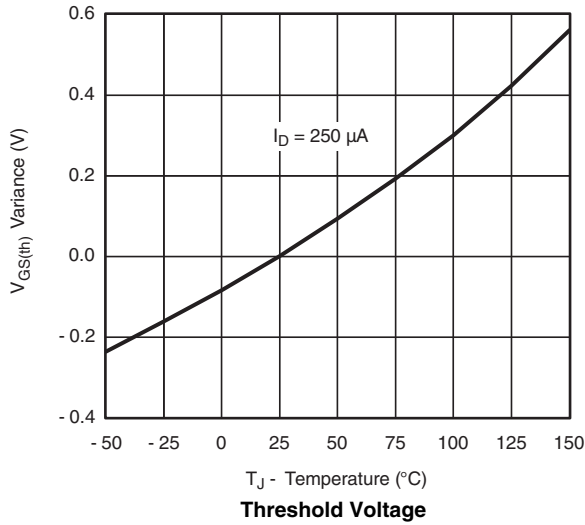


$V_{SD}$  - Source-to-Drain Voltage (V)  
**Source-Drain Diode Forward Voltage**

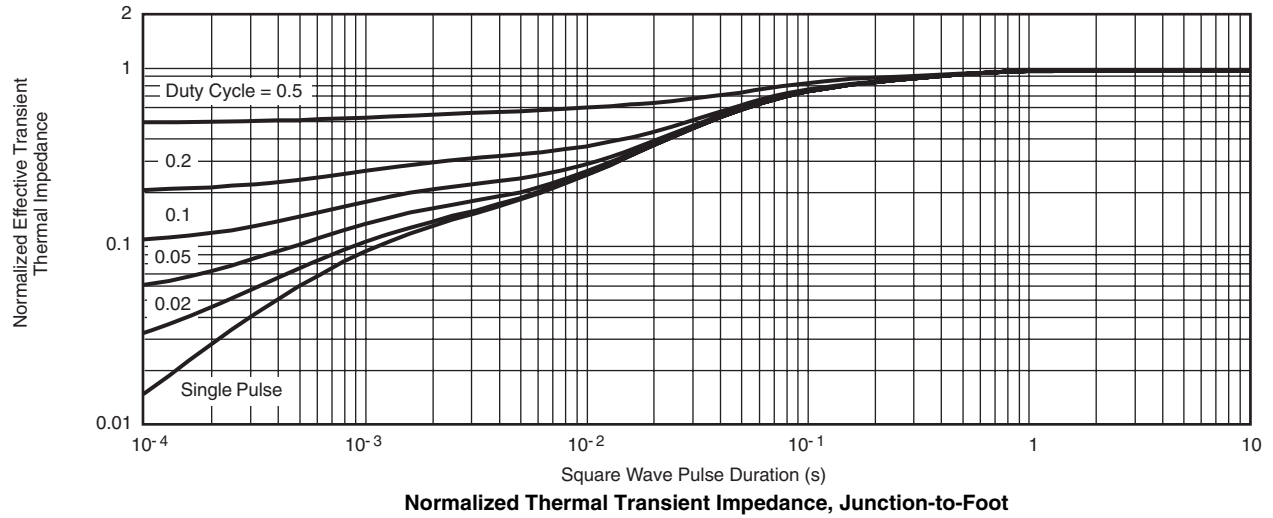


$V_{GS}$  - Gate-to-Source Voltage (V)  
**On-Resistance vs. Gate-to-Source Voltage**

**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



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